



60V P-Channel Enhancement Mode MOSFET

Voltage

-60 V

Current

-15 A

Features

- R_{DS(ON)}, V_{GS}@-10V, I_D@-7.5A<68mΩ
- $R_{DS(ON)}$, $V_{GS}@-4.5V$, $I_D@-4A<85m\Omega$
- High switching speed
- Improved dv/dt capability
- Low Gate Charge
- Low reverse transfer capacitance
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

• Case: DFN5060-8L Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.0028 ounces, 0.08 grams

DFN5060-8L

Maximum Ratings and Thermal Characteristics (T_A=25 °C unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNITS		
Drain-Source Voltage		V _{DS}	-60		
Gate-Source Voltage		V_{GS}	<u>+</u> 20	V	
Continuous Drain Current (Note 4)	T _C =25°C	l _D	-15		
	T _C =100°C		-9.5	Α	
Pulsed Drain Current (Note 1)	T _C =25°C	I _{DM}	-60		
Power Dissipation	T _C =25°C	Po	25	W	
	T _C =100°C		10		
Continuous Drain Current (Note 4)	T _A =25°C	l _D	-4	А	
	T _A =70°C		-3.2		
Power Dissipation	T _A =25°C	Г.	2	W	
	T _A =70°C	Pb	1.3		
Single Pulse Avalanche Energy (Note 6)		E _{AS}	31	mJ	
Operating Junction and Storage Temperature Range		T_J, T_{STG}	-55~150	°C	
Typical Thermal Resistance (Note 4,5)	Junction to Case	$R_{\theta JC}$	5	°C/W	
	Junction to Ambient	$R_{\theta JA}$	62.5		

Limited only By Maximum Junction Temperature





Electrical Characteristics (T_A=25 °C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Static							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =-250uA V _{DS} =V _{GS} , I _D =-250uA	-60	-	-	V	
Gate Threshold Voltage	$V_{GS(th)}$		-1	-1.63	-2.5		
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =-10V, I _D =-7.5A	-	55	68	mΩ	
		V _{GS} =-4.5V, I _D =-4A	-	73	85		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-60V, V _{GS} =0V	-	-	-1	uA	
Gate-Source Leakage Current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	<u>+</u> 100	nA	
Dynamic (Note 7)							
Total Gate Charge	Q_g	V_{DS} =-30V, I_{D} =-7.5A, V_{GS} =-10V (Note 3)	-	17	-	nC	
Gate-Source Charge	Q_gs		-	2.8	-		
Gate-Drain Charge	Q_gd		-	3.6	-		
Input Capacitance	Ciss	V _{DS} =-30V, V _{GS} =0V, f=1MHZ	-	879	-	pF	
Output Capacitance	Coss		-	70	-		
Reverse Transfer Capacitance	Crss		-	47	-		
Turn-On Delay Time	td _(on)	V_{DD} =-30V, I_{D} =-1A, V_{GS} =-10V, R_{G} =6 Ω (Note 3)	-	8.4	-	ns	
Turn-On Rise Time	t _r		-	30	-		
Turn-Off Delay Time	td _(off)		-	52	-		
Turn-Off Fall Time	t _f		-	16	-		
Drain-Source Diode							
Maximum Continuous Drain-Source			-	-	-15	А	
Diode Forward Current	I _S						
Diode Forward Voltage	V_{SD}	I _S =-1A, V _{GS} =0V	-	-0.73	-1	V	

NOTES:

- 1. Pulse width<300us, Duty cycle<2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C. Ratings are based on low frequency and duty cycles to keep initial T_J=25°C.
- 4. The maximum current rating is package limited.
- 5. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
- 6. The test condition is L=0.1mH, I_{AS} =-25A, V_{DD} =-25V, V_{GS} =-10V, Starting T_{J} =25°C.
- 7. Guaranteed by design, not subject to production testing.





TYPICAL CHARACTERISTIC CURVES

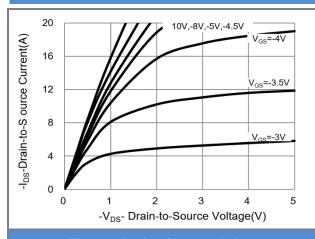


Fig.1 On-Region Characteristics

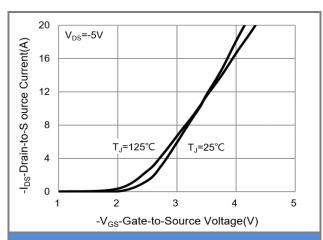


Fig.2 Transfer Characteristics

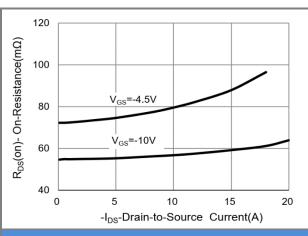


Fig.3 On-Resistance vs. Drain Current

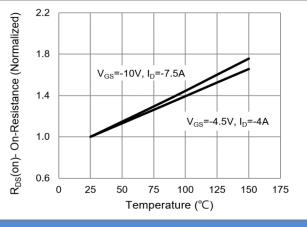


Fig.4 On-Resistance vs. Junction temperature

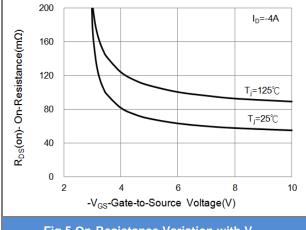


Fig.5 On-Resistance Variation with V_{GS}

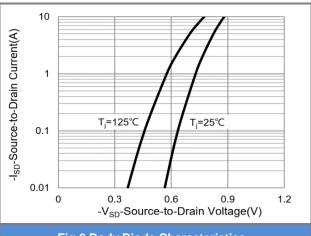


Fig.6 Body Diode Characteristics





TYPICAL CHARACTERISTIC CURVES

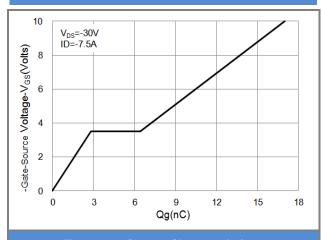


Fig.7 Gate-Charge Characteristics

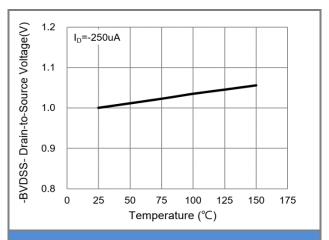


Fig.8 Breakdown Voltage Variation vs. Temperature

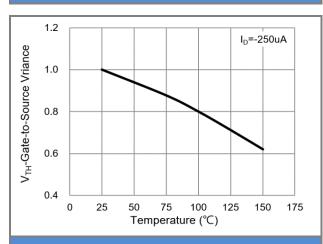


Fig.9 Threshold Voltage Variation with Temperature

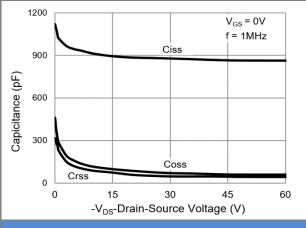


Fig.10 Capacitance vs. Drain-Source Voltage

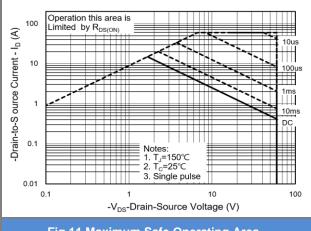


Fig.11 Maximum Safe Operating Area

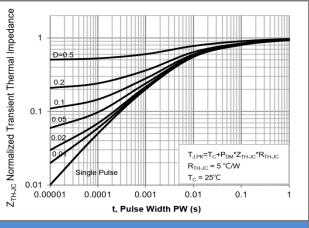


Fig.12 Normalized Thermal Transient Impedance

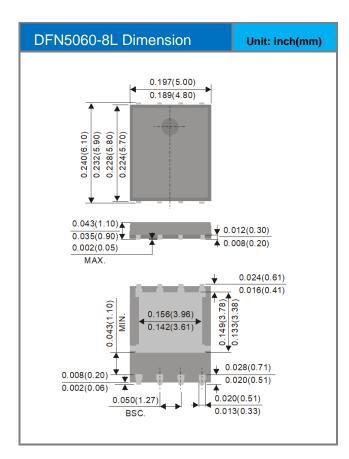


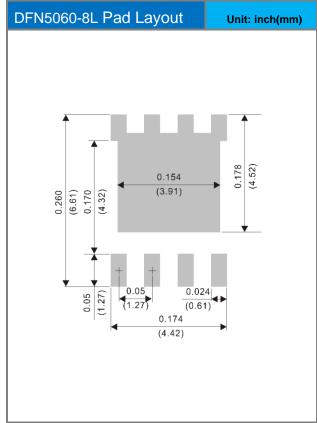


Part No Packing Code Version

Part No Packing Code	Package Type	Packing Type	Packing Type Marking	
PJQ5463A-AU_R2_000A1	DFN5060-8L	3000pcs / 13" reel	Q5463A	Halogen free

Packaging Information & Mounting Pad Layout









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